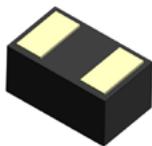


# STN161XXXUXXX

## TVS Diode ESD suppressor



### Applications

- Cellular phones
- Wearables
- Portable electronics
- Laptop/notebook computers
- Digital cameras

### Product features

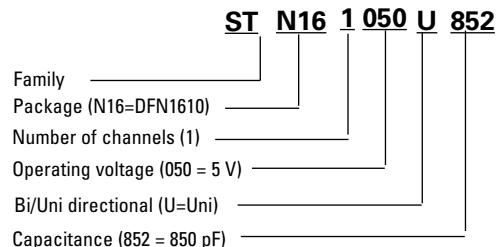
- Protects one I/O or power line
- Low clamping voltage
- Low leakage current
- Meets moisture sensitivity level (MSL) 3
- Molding compound flammability rating: UL 94V-0
- Termination finish: Tin

### Environmental compliance and general specifications

- IEC61000-4-2 (ESD)
  - Up to  $\pm 30$  kV (air)
  - Up to  $\pm 30$  kV (contact))
- IEC61000-4-5 (Lightning) Up to 110 A (8/20  $\mu$ s)



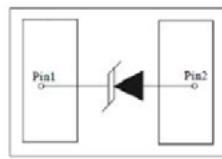
### Ordering part number



### Pin out/functional diagram



DFN1610-2L



PIN Configuration

### Absolute maximum ratings

(+25 °C, RH=45%-75%, unless otherwise noted)

Parameter	Symbol	Value	Unit
STN161XXXUXXX			
Peak pulse power dissipation on 8/20 µs waveform	P <sub>pp</sub>	2000	W
ESD per IEC 61000-4-2 (Air)	V <sub>ESD</sub>	+/-30	kV
ESD per IEC 61000-4-2 (Contact)		+/-30	
Lead soldering temperature	T <sub>L</sub>	+260 (10 seconds)	°C
Operating junction temperature range	T <sub>J</sub>	-55 to +125	°C
Storage temperature range	T <sub>STG</sub>	-55 to +150	°C

### Electrical characteristics

(+25 °C)

#### STN161050U852

Parameter	Test condition	Minimum	Typical	Maximum	Symbol (Units)
Reverse working voltage	-	-	-	5.0	V <sub>RWM</sub> (V)
Reverse breakdown voltage	I <sub>T</sub> = 1 mA	6	7	8	V <sub>BR</sub> (V)
Reverse leakage current	V <sub>RWM</sub> = 5 V	-	-	1	I <sub>R</sub> (µA)
Peak pulse current	t <sub>p</sub> = 8/20 µs	-	-	110	I <sub>pp</sub> (A)
Clamping voltage	I <sub>pp</sub> = 50 A, t <sub>p</sub> = 8/20 µs	-	11	14	V <sub>C</sub> (V)
	I <sub>pp</sub> = 80 A, t <sub>p</sub> = 8/20 µs	-	13	15	V <sub>C</sub> (V)
	I <sub>pp</sub> = 110 A, t <sub>p</sub> = 8/20 µs	-	14	17	V <sub>C</sub> (V)
Junction capacitance	V <sub>RWM</sub> = 0V, f = 1 MHz	-	850	1050	C <sub>J</sub> (pF)

#### STN161070U722

Parameter	Test condition	Minimum	Typical	Maximum	Symbol (Units)
Reverse working voltage	-	-	-	7.0	V <sub>RWM</sub> (V)
Reverse breakdown voltage	I <sub>T</sub> = 1 mA	7.5	8	9	V <sub>BR</sub> (V)
Reverse leakage current	V <sub>RWM</sub> = 7 V	-	-	1	I <sub>R</sub> (µA)
Forward voltage	I <sub>F</sub> = 10 mA	0.6	-	1	V <sub>F</sub>
Peak pulse current	t <sub>p</sub> = 8/20 µs	-	-	100	I <sub>pp</sub> (A)
Clamping voltage	I <sub>pp</sub> = 50 A, t <sub>p</sub> = 8/20 µs	-	12	15	V <sub>C</sub> (V)
	I <sub>pp</sub> = 10 A, t <sub>p</sub> = 8/20 µs		15	18	V <sub>C</sub> (V)
Junction capacitance	V <sub>RWM</sub> = 0V, f = 1 MHz	-	720	900	C <sub>J</sub> (pF)

**STN161090U602**

Parameter	Test condition	Minimum	Typical	Maximum	Symbol (Units)
Reverse working voltage	-	-	-	9.0	$V_{RWM}$ (V)
Reverse breakdown voltage	$I_T = 1 \text{ mA}$	9.5	10.5	12.5	$V_{BR}$ (V)
Reverse leakage current	$V_{RWM} = 9 \text{ V}$	-	-	1	$I_R$ ( $\mu\text{A}$ )
Forward voltage	$I_T = 10 \text{ mA}$	0.6	-	1.0	$V_F$
Peak pulse current	$t_p = 8/20 \mu\text{s}$	-	-	90	$I_{pp}$ (A)
Clamping voltage	$I_{pp} = 40 \text{ A},$ $t_p = 8/20 \mu\text{s}$	-	14	17	$V_c$ (V)
	$I_{pp} = 50 \text{ A},$ $t_p = 8/20 \mu\text{s}$	-	15	19	$V_c$ (V)
	$I_{pp} = 90 \text{ A},$ $t_p = 8/20 \mu\text{s}$	-	18	22	$V_c$ (V)
Junction capacitance	$V_{RWM} = 0\text{V}, f = 1 \text{ MHz}$	-	600	750	$C_J$ (pF)

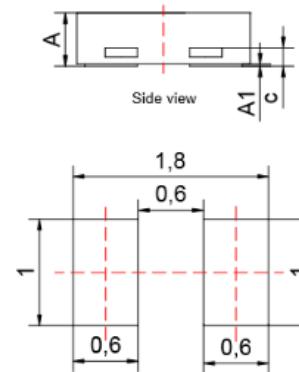
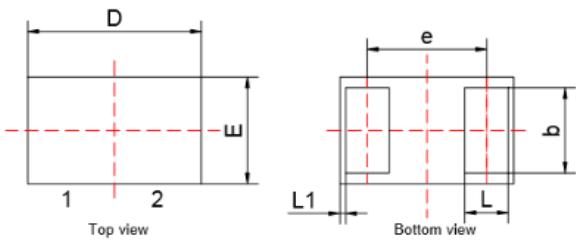
**STN161120U372**

Parameter	Test condition	Minimum	Typical	Maximum	Symbol (Units)
Reverse working voltage	-	-	-	12	$V_{RWM}$ (V)
Reverse breakdown voltage	$I_T = 1 \text{ mA}$	13.3	14.4	17	$V_{BR}$ (V)
Reverse leakage current	$V_{RWM} = 12 \text{ V}$	-	-	1	$I_R$ ( $\mu\text{A}$ )
Peak pulse current	$t_p = 8/20 \mu\text{s}$	-	-	70	$I_{pp}$ (A)
Clamping voltage	$I_{pp} = 20 \text{ A},$ $t_p = 8/20 \mu\text{s}$	-	16	19	$V_c$ (V)
	$I_{pp} = 40 \text{ A},$ $t_p = 8/20 \mu\text{s}$	-	20	24	$V_c$ (V)
	$I_{pp} = 70 \text{ A},$ $t_p = 8/20 \mu\text{s}$	-	22	28	$V_c$ (V)
Junction capacitance	$V_{RWM} = 0\text{V}, f = 1 \text{ MHz}$	-	370	450	$C_J$ (pF)

**STN161150U332**

Parameter	Test condition	Minimum	Typical	Maximum	Symbol (Units)
Reverse working voltage	-	-	-	15	$V_{RWM}$ (V)
Reverse breakdown voltage	$I_T = 1 \text{ mA}$	16	17.2	20	$V_{BR}$ (V)
Reverse leakage current	$V_{RWM} = 12 \text{ V}$	-	-	1	$I_R$ ( $\mu\text{A}$ )
Peak pulse current	$t_p = 8/20 \mu\text{s}$	-	-	55	$I_{pp}$ (A)
Clamping voltage	$I_{pp} = 25 \text{ A},$ $t_p = 8/20 \mu\text{s}$	-	22	25	$V_c$ (V)
	$I_{pp} = 50 \text{ A},$ $t_p = 8/20 \mu\text{s}$	-	26	28	$V_c$ (V)
	$I_{pp} = 55 \text{ A},$ $t_p = 8/20 \mu\text{s}$	-	27	30	$V_c$ (V)
Junction capacitance	$V_{RWM} = 0\text{V}, f = 1 \text{ MHz}$	-	330	450	$C_J$ (pF)

### Mechanical parameters, pad layout- mm



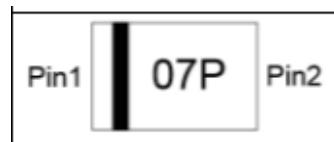
Recommended Soldering Footprint

Dimension	Minimum	Typical	Maximum
A	0.45	0.50	0.55
A1	0	0.02	0.05
b	0.85	0.90	0.95
c	0.08	0.12	0.18
D	1.55	1.60	1.65
e		1.1 BSC	
E	0.95	1.00	1.05
L	0.35	0.40	0.45
L1		0.06 BSC	

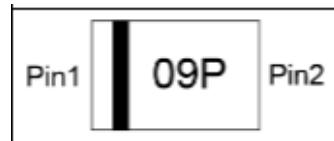
### Part marking



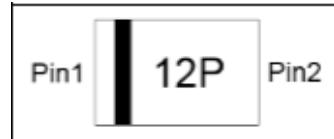
(STN161050U852)



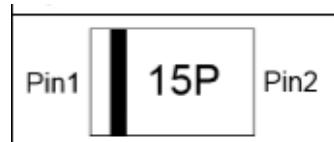
(STN161070U722)



(STN161090U602)



(STN161120U372)

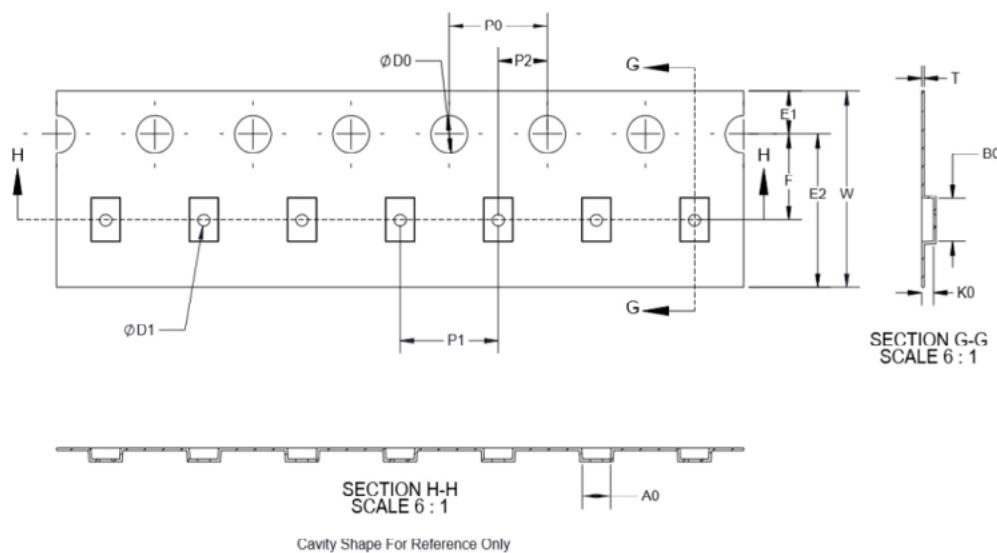


(STN161150U332)

### Packaging information mm/inches

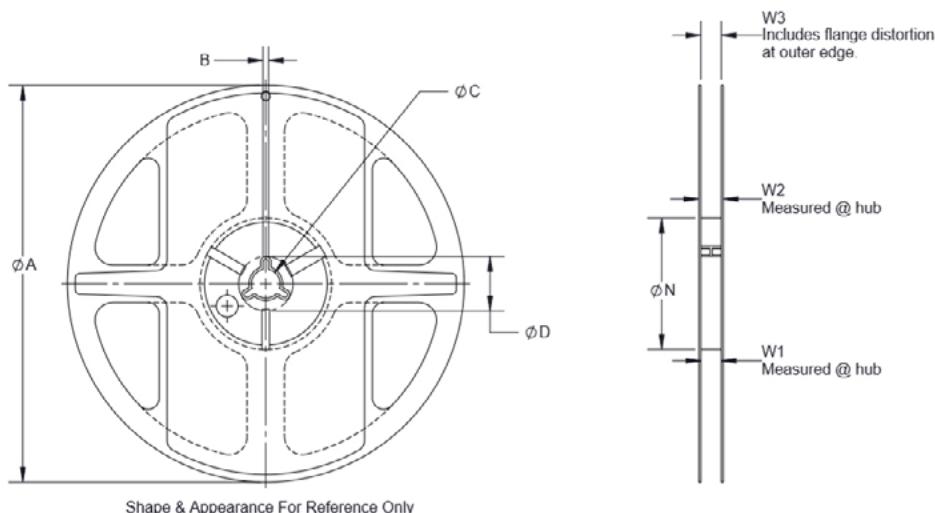
Drawing not to scale.

Supplied in tape and reel packaging, 3,000 parts per 7" diameter reel (EIA-481 compliant)



W	8 +0.2/-0.1
F	3.5±0.05
E1	1.75±0.10
E2	N/A
P0	4±0.10
P1	4±0.10
P2	2±0.05
ØD0	1.55±0.10
ØD1	0.6 +0.10/-0
A0	1.15±0.05
B0	1.75±0.05
K0	0.63±0.05
T	0.2±0.03

Cavity Shape For Reference Only

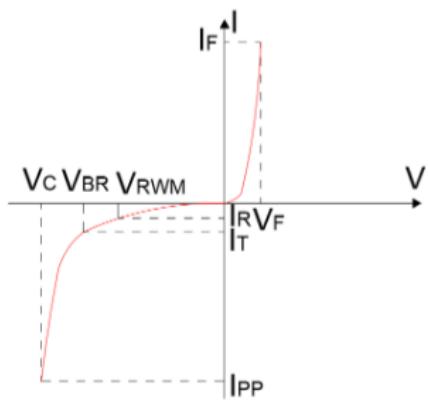


A	178
B	N/A
C	13
D	N/A
N	54.40
W1	9.50
W2	12.30
W3	N/A

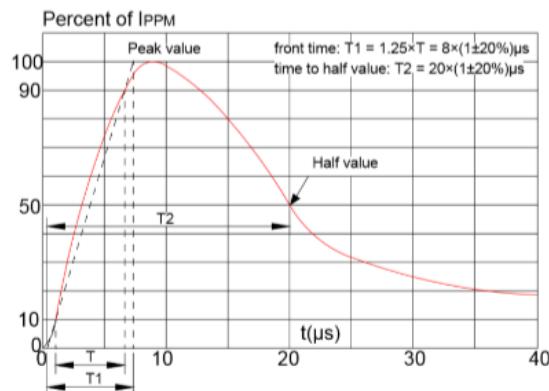
Shape & Appearance For Reference Only

**Ratings and V-I characteristic curves** (+25 °C unless otherwise noted)

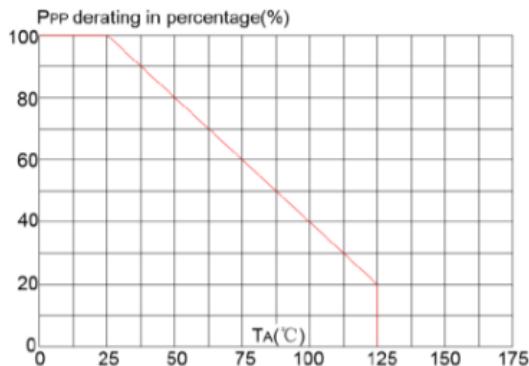
**V-I curve characteristics (uni-directional)**



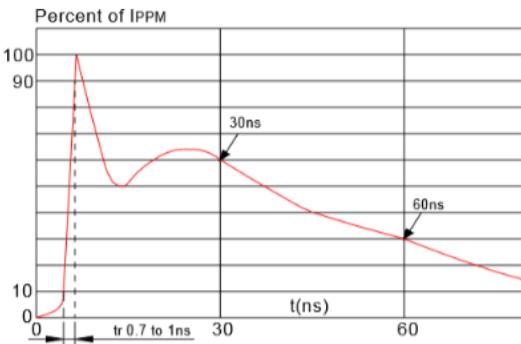
**Pulse waveform (8/20  $\mu$ s)**



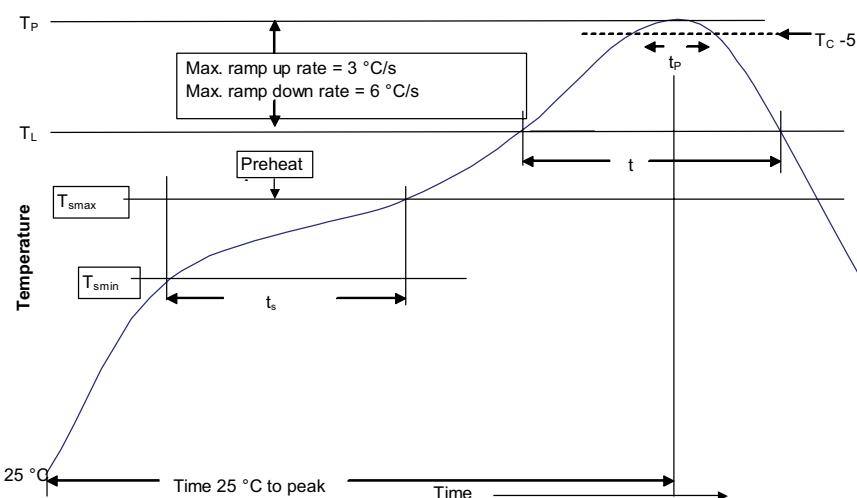
**Pulse derating curve**



**ESD waveform**



### Solder reflow profile



**Table 1 - Standard SnPb solder ( $T_c$ )**

Package thickness	Volume mm <sup>3</sup> <350	Volume mm <sup>3</sup> ≥350
<2.5 mm	235 °C	220 °C
≥2.5 mm	220 °C	220 °C

**Table 2 - Lead (Pb) free solder ( $T_c$ )**

Package thickness	Volume mm <sup>3</sup> <350	Volume mm <sup>3</sup> 350 - 2000	Volume mm <sup>3</sup> >2000
<1.6 mm	260 °C	260 °C	260 °C
1.6 - 2.5 mm	260 °C	250 °C	245 °C
>2.5 mm	250 °C	245 °C	245 °C

### Reference J-STD-020

Profile feature	Standard SnPb solder	Lead (Pb) free solder
Preheat and soak	<ul style="list-style-type: none"> <li>Temperature min. (<math>T_{smin}</math>)</li> <li>Temperature max. (<math>T_{smax}</math>)</li> <li>Time (<math>T_{smin}</math> to <math>T_{smax}</math>) (<math>t_s</math>)</li> </ul>	100 °C 150 °C 60-120 seconds
Ramp up rate $T_L$ to $T_p$	3 °C/ second max.	3 °C/ second max.
Liquidous temperature ( $T_l$ )	183 °C	217 °C
Time ( $t_L$ ) maintained above $T_L$	60-150 seconds	60-150 seconds
Peak package body temperature ( $T_p$ )*	Table 1	Table 2
Time ( $t_p$ )* within 5 °C of the specified classification temperature ( $T_c$ )	20 seconds*	30 seconds*
Ramp-down rate ( $T_p$ to $T_L$ )	6 °C/ second max.	6 °C/ second max.
Time 25 °C to peak temperature	6 minutes max.	8 minutes max.

\* Tolerance for peak profile temperature ( $T_p$ ) is defined as a supplier minimum and a user maximum.

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